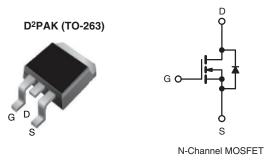
Vishay Siliconix



E Series Power MOSFET

PRODUCT SUMMARY						
V _{DS} (V) at T _J max.	550					
R _{DS(on)} max. at 25 °C (Ω)	$V_{GS} = 10 V$	0.184				
Q _g max. (nC)	92					
Q _{gs} (nC)	10					
Q _{gd} (nC)	19					
Configuration	Sing	le				



FEATURES

- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Low gate charge (Q_a)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Computing
 - PC silver box / ATX power supplies
- Lighting
 - Two stage LED lighting
- Consumer electronics
- Applications using hard switched topologies
 - Power factor correction (PFC)
 - Two switch forward converter
 - Flyback converter
- Switch mode power supplies (SMPS)

ORDERING INFORMATION Package D²PAK (TO-263) Lead (Pb)-free and Halogen-free SiHB20N50E-GE3

ABSOLUTE MAXIMUM RATINGS	č	I			
PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-Source Voltage	V _{DS}	500	v		
Gate-Source Voltage	V _{GS}	± 30	v		
Continuous Drain Current (T _{.1} = 150 °C)	V _{GS} at 10 V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$	- I _D	19	
Continuous Drain Current $(T_j = 150^{\circ} C)$	VGS at 10 V	T _C = 100 °C		12	Α
Pulsed Drain Current ^a	I _{DM}	42			
Linear Derating Factor		1.4	W/°C		
Single Pulse Avalanche Energy ^b	E _{AS}	204	mJ		
Maximum Power Dissipation	PD	179	W		
Operating Junction and Storage Temperature Ra	T _J , T _{stg}	-55 to +150	°C		
Drain-Source Voltage Slope	$V_{DS} = 0 V t$	o 80 % V _{DS}	d\//dt	70	1//20
Reverse Diode dV/dt ^d	dV/dt	32	V/ns		
Soldering Recommendations (Peak Temperature		300	°C		

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 3.8 A.

c. 1.6 mm from case.

d. $I_{SD} \leq I_D$, dl/dt = 100 A/µs, starting T_J = 25 °C.

THERMAL RESISTANCE RATINGS							
PARAMETER	SYMBOL	TYP.	MAX.	UNIT			
Maximum Junction-to-Ambient	R _{thJA}	-	62	°C/W			
Maximum Junction-to-Case (Drain)	R _{thJC}	-	0.7	0/10			

S15-0278-Rev. B, 23-Feb-15

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Document Number: 91634



COMPLIANT HALOGEN



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PARAMETER	SYMBOL	TES	TEST CONDITIONS		TYP.	MAX.	UNIT
Static		• •		•	•	•	
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250 μA	500	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I _D = 1 mA	-	0.59	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μΑ	2.0	-	4.0	V
Oata Cauraa Laskaas	I _{GSS}		$V_{GS} = \pm 20 V$			± 100	nA
Gate-Source Leakage			V _{GS} = ± 30 V	-	-	± 1	μA
Zaus Osta Valta za Dusia Ouwant	I _{DSS}	V _{DS} =	$V_{DS} = 500 \text{ V}, V_{GS} = 0 \text{ V}$			1	
Zero Gate Voltage Drain Current		V _{DS} = 400 V	$V_{DS} = 400 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 \text{ °C}$			10	μA
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = 10 V$	I _D = 10 A	-	0.160	0.184	Ω
Forward Transconductance	g fs	V _{DS}	= 30 V, I _D = 10 A	-	4.4	-	S
Dynamic					•		
Input Capacitance	C _{iss}		V _{GS} = 0 V,	-	1640	-	
Output Capacitance	C _{oss}		$V_{DS} = 100 V,$	-	87	-	
Reverse Transfer Capacitance	C _{rss}		f = 1 MHz	-	6	-	
Effective Output Capacitance, Energy Related ^a	C _{o(er)}		$V_{DS} = 0 V$ to 400 V, $V_{GS} = 0 V$		73	-	pF
Effective Output Capacitance, Time Related ^b	C _{o(tr)}	$ V_{DS} = 0$ V			222	-	
Total Gate Charge	Qq			-	46	92	
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	I _D = 10 A, V _{DS} = 400 V	-	10	-	nC
Gate-Drain Charge	Q _{qd}			-	19	-	
Turn-On Delay Time	t _{d(on)}				17	34	
Rise Time	t _r	Vee -	= 400 V, I _D = 10 A,	-	27	54	-
Turn-Off Delay Time	t _{d(off)}		$V_{DD} = 400 \text{ V}, \text{ I}_D = 10 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_a = 9.1 \Omega$		48	96	ns
Fall Time	t _f			-	25	50	
Gate Input Resistance	Rg	f = 1 MHz, open drain		-	0.83	-	Ω
Drain-Source Body Diode Characteristic	S	•		•	•	•	
Continuous Source-Drain Diode Current	I _S	MOSFET sym showing the	MOSFET symbol showing the integral reverse p - n junction diode		-	19	
Pulsed Diode Forward Current	I _{SM}	Ũ			-	42	A
Diode Forward Voltage	V _{SD}	T _{.J} = 25 °C	C, I _S = 10 A, V _{GS} = 0 V	-	-	1.2	V
Reverse Recovery Time	t _{rr}			-	293	-	ns
Reverse Recovery Charge	Q _{rr}	$T_J = 2$	5 °C, $I_F = I_S = 10 \text{ A}$,	-	4.0	-	μC
Reverse Recovery Current	I _{BBM}		100 A/µs, V _R = 25 V	-	26	-	A

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} . b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

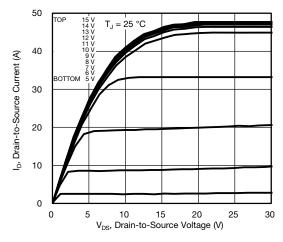


Fig. 1 - Typical Output Characteristics

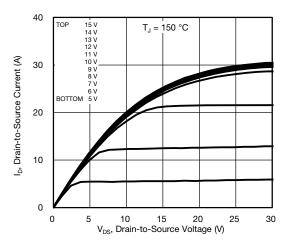


Fig. 2 - Typical Output Characteristics

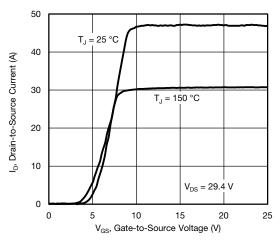


Fig. 3 - Typical Transfer Characteristics

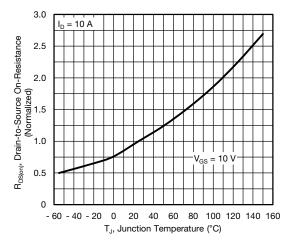


Fig. 4 - Normalized On-Resistance vs. Temperature

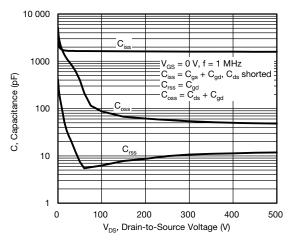


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

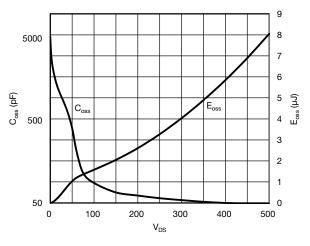


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}

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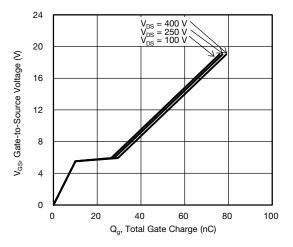


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

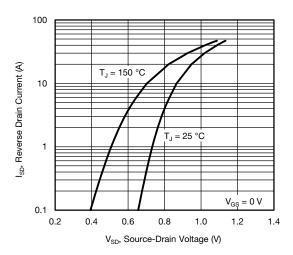


Fig. 8 - Typical Source-Drain Diode Forward Voltage

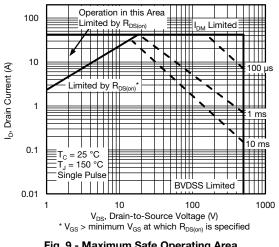


Fig. 9 - Maximum Safe Operating Area

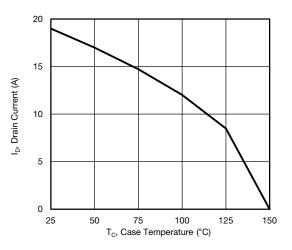


Fig. 10 - Maximum Drain Current vs. Case Temperature

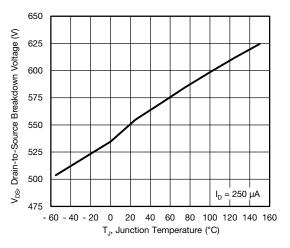
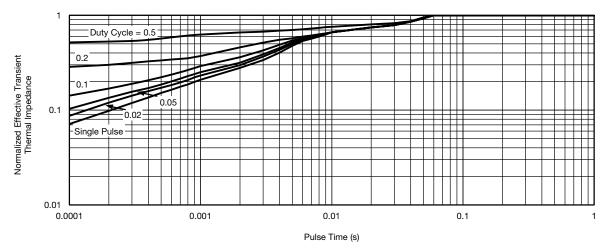


Fig. 11 - Temperature vs. Drain-to-Source Voltage



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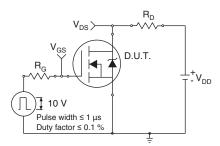


Fig. 13 - Switching Time Test Circuit

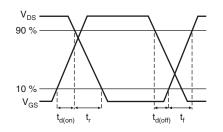


Fig. 14 - Switching Time Waveforms

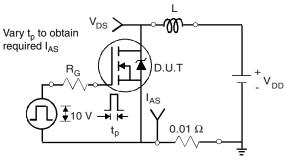


Fig. 15 - Unclamped Inductive Test Circuit

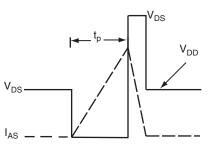


Fig. 16 - Unclamped Inductive Waveforms

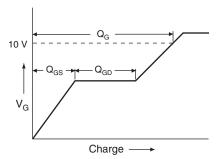
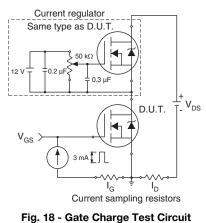


Fig. 17 - Basic Gate Charge Waveform



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Peak Diode Recovery dV/dt Test Circuit

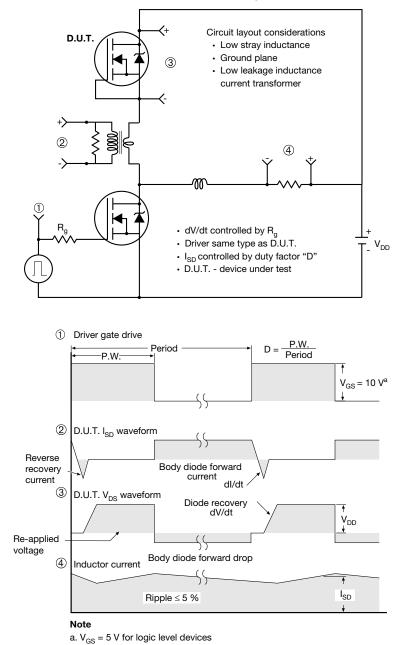


Fig. 19 - For N-Channel

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H

A1

B

Gauge plane

L3

Detail "A" Rotated 90° CW scale 8:1

0° to 8° **Vishay Siliconix**

Seating plane

TO-263AB (HIGH VOLTAGE)

∕3 ⁄4 A

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Detail A

(Datum A)

D

 $\underline{4}$ 11

	2	-	Y 2 x b2 2 x b ⊕ 0.010 @ A(■ ating 5 b1, b b1, b b1, b c) c) c) c) c) c) c) c) c) c)	$\begin{array}{c} c_{1} \\ c_{1} \\ c_{2} \\ c_{3} \\ c_{4} \\ c_{5} \\ c_{7} \\$	a - 1		Ū.	1 <u>4</u>		
	MILLIN	IETERS	INCHES				MILLIN	MILLIMETERS		INCHES	
DIM.	MIN.	MAX.	MIN.	MAX.		DIM.	MIN.	MAX.	MIN.	MAX.	
А	4.06	4.83	0.160	0.190		D1	6.86	-	0.270	-	
				0.010		-		10.07	0.000	0.420	
A1	0.00	0.25	0.000	0.010		E	9.65	10.67	0.380	0.120	
A1 b	0.00 0.51	0.25 0.99	0.000	0.010		E1	9.65 6.22	- 10.67	0.380	-	
							6.22	- 10.67 - BSC	0.245	- BSC	
b	0.51	0.99	0.020	0.039		E1	6.22	-	0.245	-	
b b1	0.51 0.51	0.99 0.89	0.020 0.020	0.039 0.035		E1 e	6.22 2.54	- BSC	0.245	-) BSC	
b b1 b2	0.51 0.51 1.14	0.99 0.89 1.78	0.020 0.020 0.045	0.039 0.035 0.070		E1 e H	6.22 2.54 14.61	- BSC 15.88	0.245 0.100 0.575	-) BSC 0.625	
b b1 b2 b3	0.51 0.51 1.14 1.14	0.99 0.89 1.78 1.73	0.020 0.020 0.045 0.045	0.039 0.035 0.070 0.068		E1 e H L	6.22 2.54 14.61 1.78	- BSC 15.88 2.79	0.245 0.100 0.575 0.070	- 0 BSC 0.625 0.110	
b b1 b2 b3 c	0.51 0.51 1.14 1.14 0.38	0.99 0.89 1.78 1.73 0.74	0.020 0.020 0.045 0.045 0.015	0.039 0.035 0.070 0.068 0.029		E1 e H L L1	6.22 2.54 14.61 1.78 - -	- BSC 15.88 2.79 1.65	0.245 0.100 0.575 0.070 - -	- 0 BSC 0.625 0.110 0.066	
b b1 b2 b3 c c1	0.51 0.51 1.14 1.14 0.38 0.38	0.99 0.89 1.78 1.73 0.74 0.58	0.020 0.020 0.045 0.045 0.015 0.015	0.039 0.035 0.070 0.068 0.029 0.023		E1 e H L L1 L2	6.22 2.54 14.61 1.78 - -	- BSC 15.88 2.79 1.65 1.78	0.245 0.100 0.575 0.070 - -	- 0 BSC 0.625 0.110 0.066 0.070	

Α

Notes

1. Dimensioning and tolerancing per ASME Y14.5M-1994.

2. Dimensions are shown in millimeters (inches).

3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body at datum A.

4. Thermal PAD contour optional within dimension E, L1, D1 and E1.

5. Dimension b1 and c1 apply to base metal only.

6. Datum A and B to be determined at datum plane H.

7. Outline conforms to JEDEC outline to TO-263AB.



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RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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